

# Technische Information / Technical Information

IGBT-Module  
IGBT-Modules

# FP15R12KE3

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Vorläufig  
Preliminary

## Elektrische Eigenschaften / Electrical properties

### Höchstzulässige Werte / Maximum rated values

#### Diode Gleichrichter/ Diode Rectifier

Periodische Rückw. Spitzensperrspannung repetitive peak reverse voltage	$T_{vj} = 25^\circ C$	$V_{RRM}$	1600	V
Durchlaßstrom Grenzeffektivwert pro Chip RMS forward current per chip	$T_C = 80^\circ C$	$I_{FRMSM}$	25	A
Gleichrichter Ausgang Grenzeffektivstrom maximum RMS current at Rectifier output	$T_C = 80^\circ C$	$I_{RMSSmax}$	36	A
Stoßstrom Grenzwert surge forward current	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$ $t_p = 10 \text{ ms}, T_{vj} = 150^\circ C$	$I_{FSM}$	196 158	A A
Grenzlastintegral $I^2t$ - value	$t_p = 10 \text{ ms}, T_{vj} = 25^\circ C$ $t_p = 10 \text{ ms}, T_{vj} = 150^\circ C$	$I^2t$	192 125	$A^2s$ $A^2s$

#### Transistor Wechselrichter/ Transistor Inverter

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^\circ C$	$V_{CES}$	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ C$ $T_C = 25^\circ C$	$I_{C,nom.}$ $I_C$	15 27	A A
Periodischer Kollektor Spitzstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 80^\circ C$	$I_{CRM}$	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ C$	$P_{tot}$	89	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

#### Diode Wechselrichter/ Diode Inverter

Dauergleichstrom DC forward current		$I_F$	15	A
Periodischer Spitzstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	$I_{FRM}$	30	A
Grenzlastintegral $I^2t$ - value	$V_R = 0V, t_p = 10ms, T_{vj} = 125^\circ C$	$I^2t$	44	$A^2s$

#### Transistor Brems-Chopper/ Transistor Brake-Chopper

Kollektor-Emitter-Sperrspannung collector-emitter voltage	$T_{vj} = 25^\circ C$	$V_{CES}$	1200	V
Kollektor-Dauergleichstrom DC-collector current	$T_C = 80^\circ C$ $T_C = 25^\circ C$	$I_{C,nom.}$ $I_C$	15 27	A A
Periodischer Kollektor Spitzstrom repetitive peak collector current	$t_p = 1 \text{ ms}, T_C = 80^\circ C$	$I_{CRM}$	30	A
Gesamt-Verlustleistung total power dissipation	$T_C = 25^\circ C$	$P_{tot}$	89	W
Gate-Emitter-Spitzenspannung gate-emitter peak voltage		$V_{GES}$	+/- 20V	V

#### Diode Brems-Chopper/ Diode Brake-Chopper

Dauergleichstrom DC forward current		$I_F$	15	A
Periodischer Spitzstrom repetitive peak forw. current	$t_p = 1 \text{ ms}$	$I_{FRM}$	30	A

prepared by: Thomas Passe	date of publication: 2002-02-13
approved by: Ingo Graf	revision: 6

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## Modul Isolation/ Module Isolation

Isolations-Prüfspannung insulation test voltage	RMS, f = 50 Hz, t = 1 min. NTC connected to Baseplate	V <sub>ISOL</sub>	2,5	kV
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## Elektrische Eigenschaften / Electrical properties

### Charakteristische Werte / Characteristic values

#### Diode Gleichrichter/ Diode Rectifier

			min.	typ.	max.	
Durchlaßspannung forward voltage	T <sub>vj</sub> = 150°C, I <sub>f</sub> = 15 A	V <sub>F</sub>	-	1,05	-	V
Schleusenspannung threshold voltage	T <sub>vj</sub> = 150°C	V <sub>(TO)</sub>	-	0,80	-	V
Ersatzwiderstand slope resistance	T <sub>vj</sub> = 150°C	r <sub>T</sub>	-	15	-	mΩ
Sperrstrom reverse current	T <sub>vj</sub> = 150°C, V <sub>R</sub> = 1600 V	I <sub>R</sub>	-	5	-	mA
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T <sub>C</sub> = 25°C	R <sub>AA'+CC'</sub>	-	11	-	mΩ

#### Transistor Wechselrichter/ Transistor Inverter

			min.	typ.	max.	
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V <sub>GE</sub> = 15V, T <sub>vj</sub> = 25°C, I <sub>C</sub> = 15 A V <sub>GE</sub> = 15V, T <sub>vj</sub> = 125°C, I <sub>C</sub> = 15 A	V <sub>CE sat</sub>	-	1,7	2,15	V
Gate-Schwellenspannung gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , T <sub>vj</sub> = 25°C, I <sub>C</sub> = 0,5mA	V <sub>GE(TO)</sub>	4,5	5,5	6,5	V
Eingangskapazität input capacitance	f = 1MHz, T <sub>vj</sub> = 25°C V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V	C <sub>ies</sub>	-	1,0	-	nF
Kollektor-Emitter Reststrom collector-emitter cut-off current	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 125°C, V <sub>CE</sub> = 1200V	I <sub>ces</sub>	-	5,0	-	mA
Gate-Emitter Reststrom gate-emitter leakage current	V <sub>CE</sub> = 0V, V <sub>GE</sub> = 20V, T <sub>vj</sub> = 25°C	I <sub>ges</sub>	-	-	400	nA
Einschaltverzögerungszeit (ind. Last) turn on delay time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 600 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>d,on</sub>	-	56	-	ns
Anstiegszeit (induktive Last) rise time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 600 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>r</sub>	-	30	-	ns
Abschaltverzögerungszeit (ind. Last) turn off delay time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 600 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>d,off</sub>	-	337	-	ns
Fallzeit (induktive Last) fall time (inductive load)	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 600 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 25°C, R <sub>G</sub> = 68 Ohm V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm	t <sub>f</sub>	-	421	-	ns
Einschaltverlustenergie pro Puls turn-on energy loss per pulse	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 600 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm L <sub>S</sub> = 80 nH	E <sub>on</sub>	-	2,2	-	mWs
Abschaltverlustenergie pro Puls turn-off energy loss per pulse	I <sub>C</sub> = I <sub>Nenn</sub> , V <sub>CC</sub> = 600 V V <sub>GE</sub> = ±15V, T <sub>vj</sub> = 125°C, R <sub>G</sub> = 68 Ohm L <sub>S</sub> = 80 nH	E <sub>off</sub>	-	1,6	-	mWs
Kurzschlußverhalten SC Data	t <sub>p</sub> ≤ 10µs, V <sub>GE</sub> ≤ 15V, R <sub>G</sub> = 68 Ohm T <sub>vj</sub> ≤ 125°C, V <sub>CC</sub> = 720 V	I <sub>sc</sub>	-	68	-	A

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### Elektrische Eigenschaften / Electrical properties

#### Charakteristische Werte / Characteristic values

					min.	typ.	max.
Modulinduktivität stray inductance module			L <sub>oCE</sub>	-	-	40	nH
Modul Leitungswiderstand, Anschlüsse-Chip lead resistance, terminals-chip	T <sub>C</sub> = 25°C	R <sub>CC+EE'</sub>	-	14	-	mΩ	

#### Diode Wechselrichter/ Diode Inverter

					min.	typ.	max.
Durchlaßspannung forward voltage	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 25°C, I <sub>F</sub> = 15 A V <sub>GE</sub> = 0V, T <sub>vj</sub> = 125°C, I <sub>F</sub> = 15 A	V <sub>F</sub>	-	1,7	2,1	V	
Rückstromspitze peak reverse recovery current	I <sub>F</sub> =I <sub>Nenn</sub> - di <sub>F</sub> /dt = 500 A/us V <sub>GE</sub> = -10V, T <sub>vj</sub> = 25°C, V <sub>R</sub> = 600 V V <sub>GE</sub> = -10V, T <sub>vj</sub> = 125°C, V <sub>R</sub> = 600 V	I <sub>RM</sub>	-	18	-	A	
Sperrverzögerungsladung recovered charge	I <sub>F</sub> =I <sub>Nenn</sub> - di <sub>F</sub> /dt = 500 A/us V <sub>GE</sub> = -10V, T <sub>vj</sub> = 25°C, V <sub>R</sub> = 600 V V <sub>GE</sub> = -10V, T <sub>vj</sub> = 125°C, V <sub>R</sub> = 600 V	Q <sub>r</sub>	-	1,6	-	μAs	
Abschaltenergie pro Puls reverse recovery energy	I <sub>F</sub> =I <sub>Nenn</sub> - di <sub>F</sub> /dt = 500 A/us V <sub>GE</sub> = -10V, T <sub>vj</sub> = 25°C, V <sub>R</sub> = 600 V V <sub>GE</sub> = -10V, T <sub>vj</sub> = 125°C, V <sub>R</sub> = 600 V	E <sub>rec</sub>	-	0,5	-	mWs	
			-	1	-	mWs	

#### Transistor Brems-Chopper/ Transistor Brake-Chopper

					min.	typ.	max.
Kollektor-Emitter Sättigungsspannung collector-emitter saturation voltage	V <sub>GE</sub> = 15V, T <sub>vj</sub> = 25°C, I <sub>C</sub> = 15,0 A V <sub>GE</sub> = 15V, T <sub>vj</sub> = 125°C, I <sub>C</sub> = 15,0 A	V <sub>CE sat</sub>	-	1,7	2,15	V	
Gate-Schwellenspannung gate threshold voltage	V <sub>CE</sub> = V <sub>GE</sub> , T <sub>vj</sub> = 25°C, I <sub>C</sub> = 0,5mA	V <sub>GE(TO)</sub>	4,5	5,5	6,5	V	
Eingangskapazität input capacitance	f = 1MHz, T <sub>vj</sub> = 25°C V <sub>CE</sub> = 25 V, V <sub>GE</sub> = 0 V	C <sub>ies</sub>	-	1,1	-	nF	
Kollektor-Emitter Reststrom collector-emitter cut-off current	V <sub>GE</sub> = 0V, T <sub>vj</sub> = 125°C, V <sub>CE</sub> = 1200V		-	5,0	-	mA	
Gate-Emitter Reststrom gate-emitter leakage current	V <sub>CE</sub> = 0V, V <sub>GE</sub> = 20V, T <sub>vj</sub> = 25°C	I <sub>GES</sub>	-	-	400	nA	

#### Diode Brems-Chopper/ Diode Brake-Chopper

					min.	typ.	max.
Durchlaßspannung forward voltage	T <sub>vj</sub> = 25°C, I <sub>F</sub> = 15A T <sub>vj</sub> = 125°C, I <sub>F</sub> = 15A	V <sub>F</sub>	-	2,05	2,65	V	
			-	2,15	-	V	

#### NTC-Widerstand/ NTC-Thermistor

					min.	typ.	max.
Nennwiderstand rated resistance	T <sub>C</sub> = 25°C	R <sub>25</sub>	-	5	-	kΩ	
Abweichung von R <sub>100</sub> deviation of R <sub>100</sub>	T <sub>C</sub> = 100°C, R <sub>100</sub> = 493 Ω	ΔR/R	-5		5	%	
Verlustleistung power dissipation	T <sub>C</sub> = 25°C	P <sub>25</sub>			20	mW	
B-Wert B-value	R <sub>2</sub> = R <sub>1</sub> exp [B(1/T <sub>2</sub> - 1/T <sub>1</sub> )]	B <sub>25/50</sub>		3375		K	

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### Thermische Eigenschaften / Thermal properties

				min.	typ.	max.
Innerer Wärmewiderstand thermal resistance, junction to heatsink	Gleichr. Diode/ Rectif. Diode	$\lambda_{\text{Paste}}=1\text{W/m}^{\circ}\text{K}$	R <sub>thJH</sub>	-	1,9	-
	Trans. Wechsr./ Trans. Inverter	$\lambda_{\text{grease}}=1\text{W/m}^{\circ}\text{K}$		-	1,6	-
	Diode Wechsr./ Diode Inverter			-	3,2	-
	Trans. Bremse/ Trans. Brake			-	1,6	-
	Diode Bremse/ Diode Brake			-	4,0	-
Innerer Wärmewiderstand thermal resistance, junction to case	Gleichr. Diode/ Rectif. Diode		R <sub>thJC</sub>	-	-	1,9
	Trans. Wechsr./ Trans. Inverter			-	-	1,4
	Diode Wechsr./ Diode Inverter			-	-	2,4
	Trans. Bremse/ Trans. Brake			-	-	1,4
	Diode Bremse/ Diode Brake			-	-	2,9
Übergangs-Wärmewiderstand thermal resistance, case to heatsink	Gleichr. Diode/ Rectif. Diode	$\lambda_{\text{Paste}}=1\text{W/m}^{\circ}\text{K}$	R <sub>thCH</sub>	-	0,2	-
	Trans. Wechsr./ Trans. Inverter	$\lambda_{\text{grease}}=1\text{W/m}^{\circ}\text{K}$		-	0,3	-
	Diode Wechsr./ Diode Inverter			-	1	-
	Trans. Bremse/ Trans. Brake			-	0,3	-
	Diode Bremse/ Diode Brake			-	1,4	-
Höchstzulässige Sperrsichttemperatur maximum junction temperature			T <sub>vj</sub>	-	-	150 °C
Betriebstemperatur operation temperature			T <sub>op</sub>	-40	-	125 °C
Lagertemperatur storage temperature			T <sub>stg</sub>	-40	-	125 °C

### Mechanische Eigenschaften / Mechanical properties

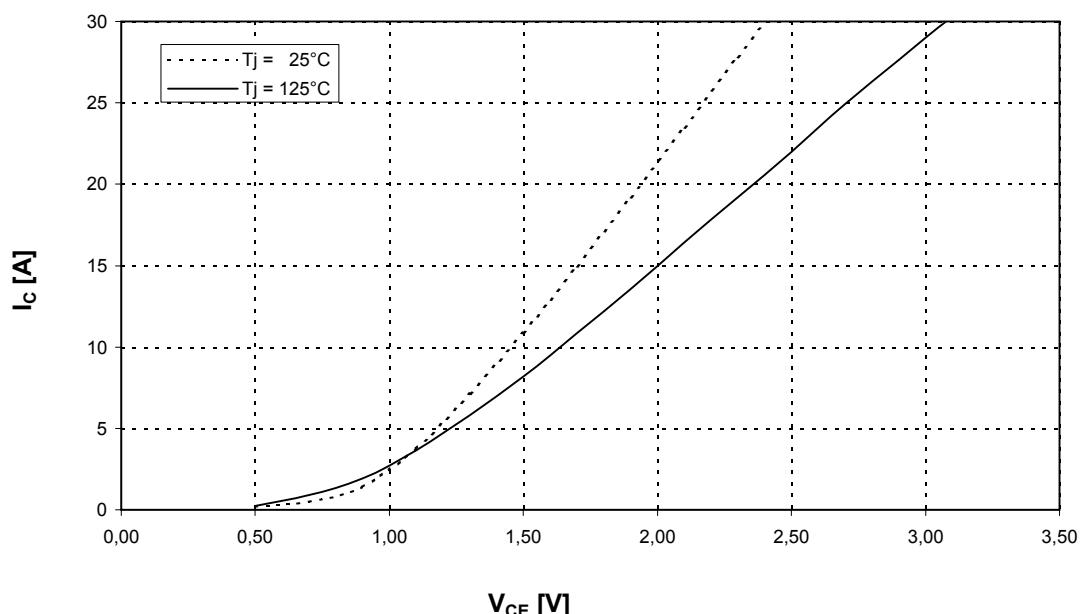
Innere Isolation internal insulation			Al <sub>2</sub> O <sub>3</sub>	
CTI comperative tracking index			225	
Anpreßkraft f. mech. Befestigung mounting force		F	40...80	N
Gewicht weight		G	36	g
Kontakt - Kühlkörper terminal to heatsink	Kriechstrecke creeping distance		13,5	mm
	Luftstrecke clearance		12	mm
Terminal - Terminal terminal - terminal	Kriechstrecke creeping distance		7,5	mm
	Luftstrecke clearance		7,5	mm

Vorläufig  
Preliminary

## Ausgangskennlinienfeld Wechselr. (typisch)

Output characteristic Inverter (typical)

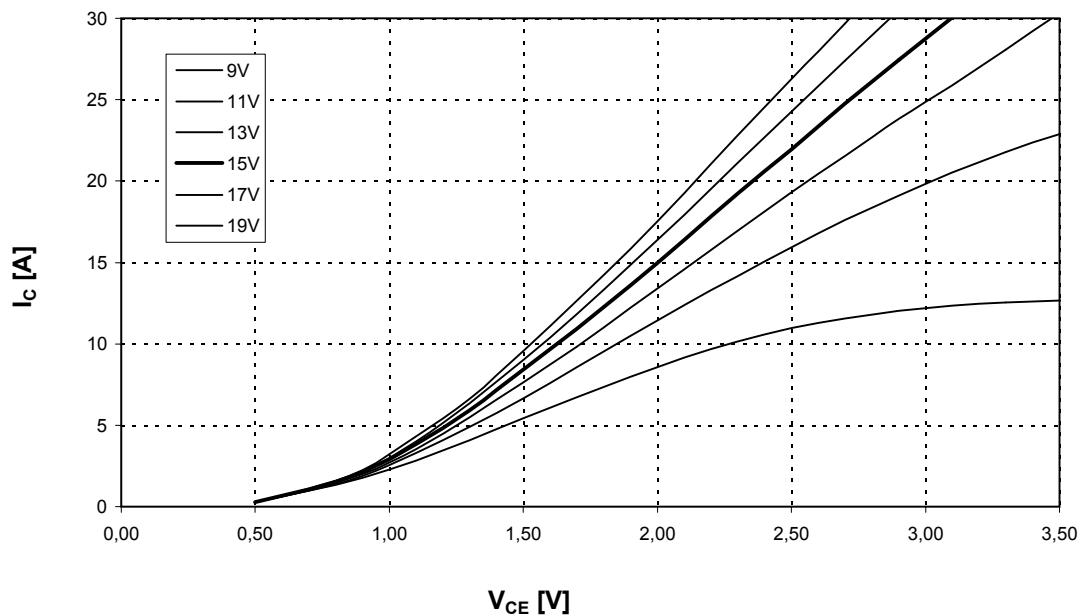
$I_C = f(V_{CE})$

 $V_{GE} = 15 \text{ V}$ 

## Ausgangskennlinienfeld Wechselr. (typisch)

Output characteristic Inverter (typical)

$I_C = f(V_{CE})$

 $T_{vj} = 125^\circ\text{C}$ 

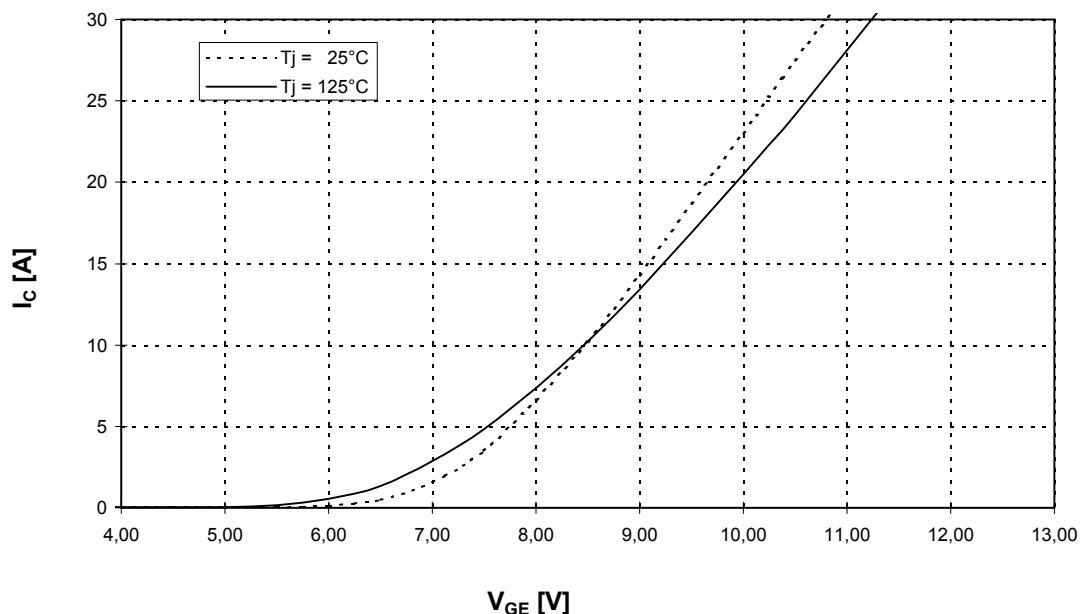
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Übertragungscharakteristik Wechselr. (typisch)

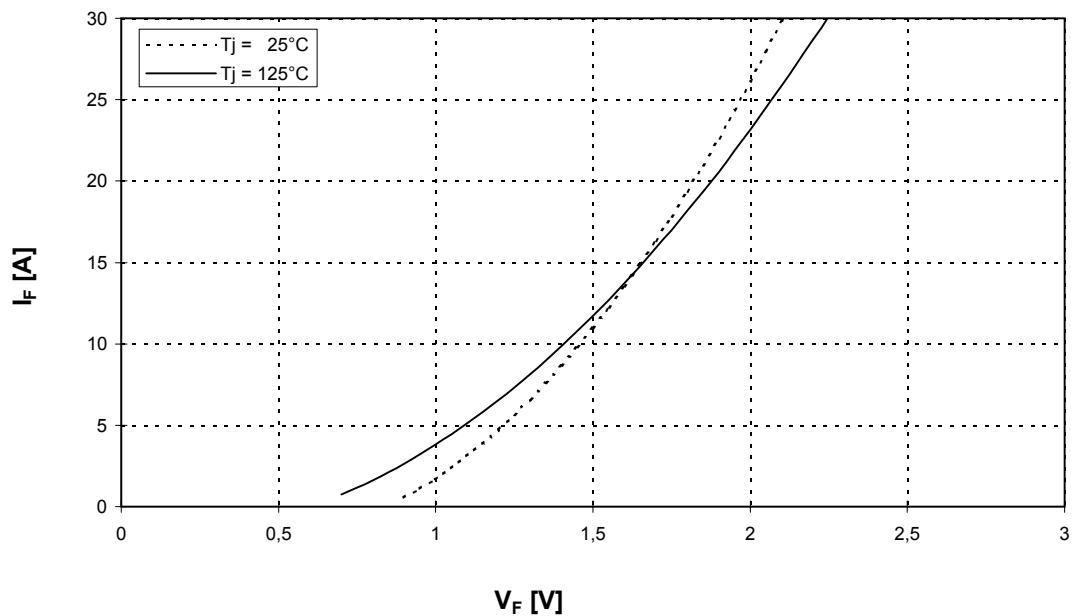
Transfer characteristic Inverter (typical)

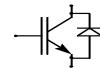
$$I_C = f(V_{GE})$$

$$V_{CE} = 20 \text{ V}$$

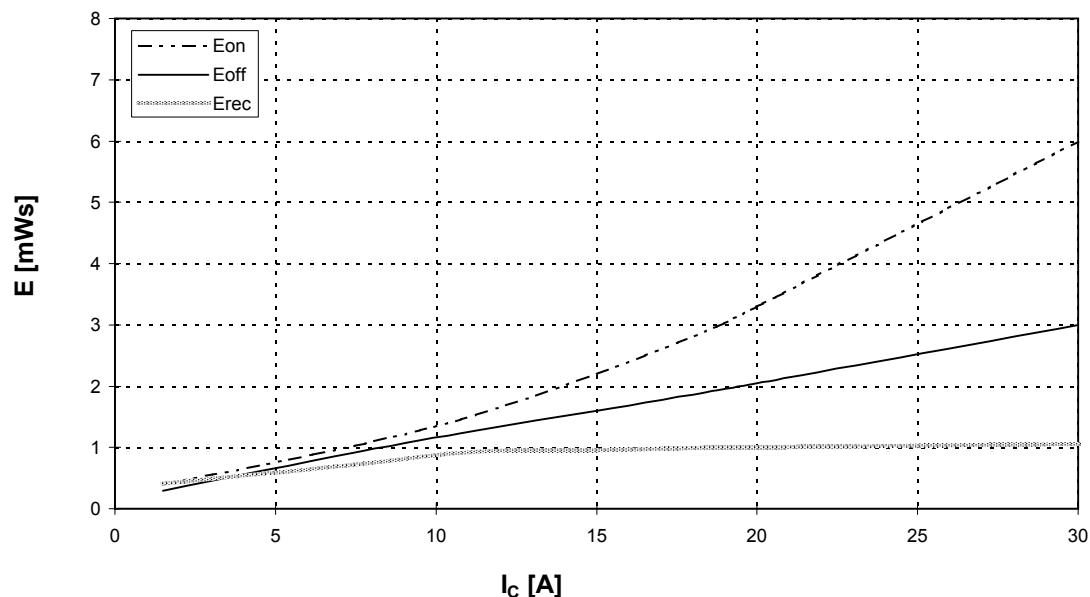
Durchlaßkennlinie der Freilaufdiode Wechselr. (typisch)  $I_F = f(V_F)$ 

Forward characteristic of FWD Inverter (typical)

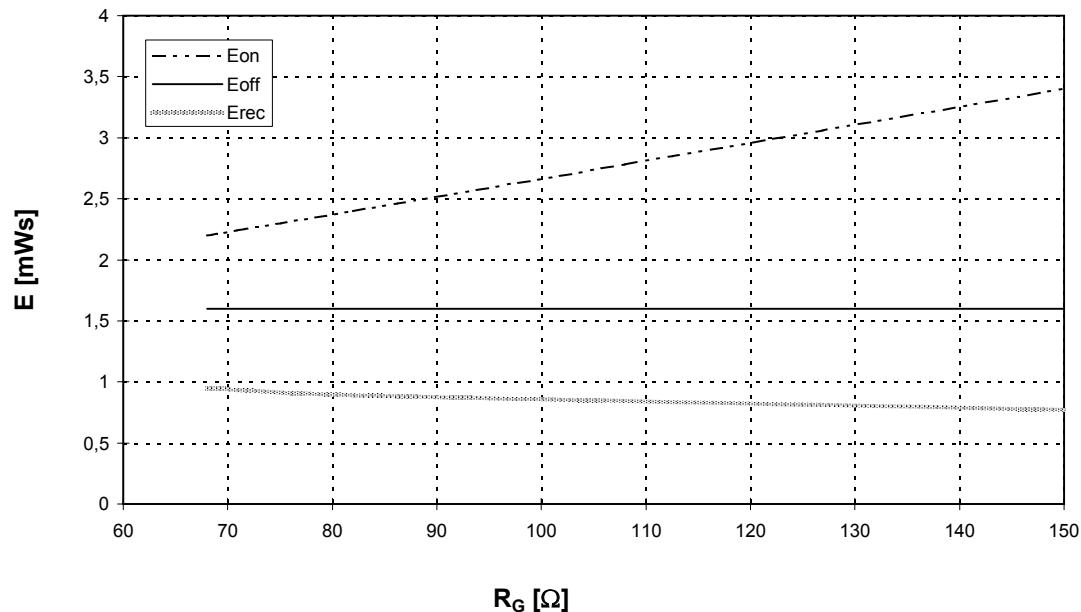


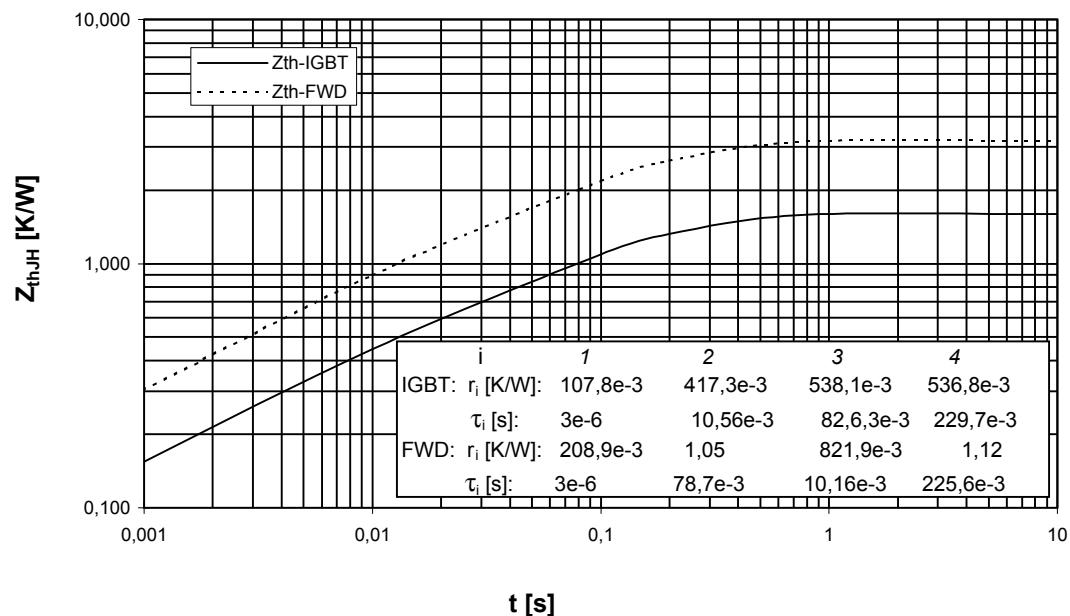
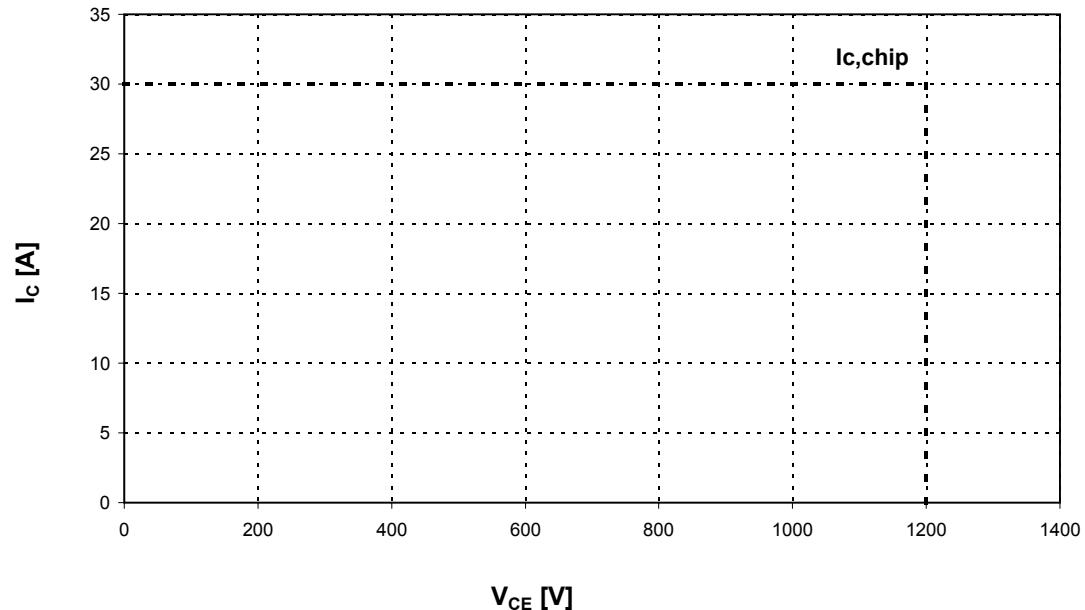
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**Schaltverluste Wechselr. (typisch)**  $E_{on} = f(I_c)$ ,  $E_{off} = f(I_c)$ ,  $E_{rec} = f(R_G)$   $V_{CC} = 600 V$   
**Switching losses Inverter (typical)**  $T_J = 125^\circ C$ ,  $V_{GE} = \pm 15 V$ ,  $R_{Gon} = R_{Goff} = 68 \text{ Ohm}$



**Schaltverluste Wechselr. (typisch)**  $E_{on} = f(R_G)$ ,  $E_{off} = f(R_G)$ ,  $E_{rec} = f(R_G)$   
**Switching losses Inverter (typical)**  $T_J = 125^\circ C$ ,  $V_{GE} = +15 V$ ,  $I_c = I_{henn}$ ,  $V_{CC} = 600 V$



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**Transienter Wärmewiderstand Wechselr.**       $Z_{\text{thJH}} = f(t)$   
**Transient thermal impedance Inverter**

**Sicherer Arbeitsbereich Wechselr. (RBSOA)**       $I_C = f(V_{CE})$   
**Reverse bias save operating area Inverter (RBSOA)**  $T_{vj} = 125^\circ\text{C}$ ,  $V_{GE} = \pm 15\text{V}$ ,  $R_G = 68 \Omega$ 




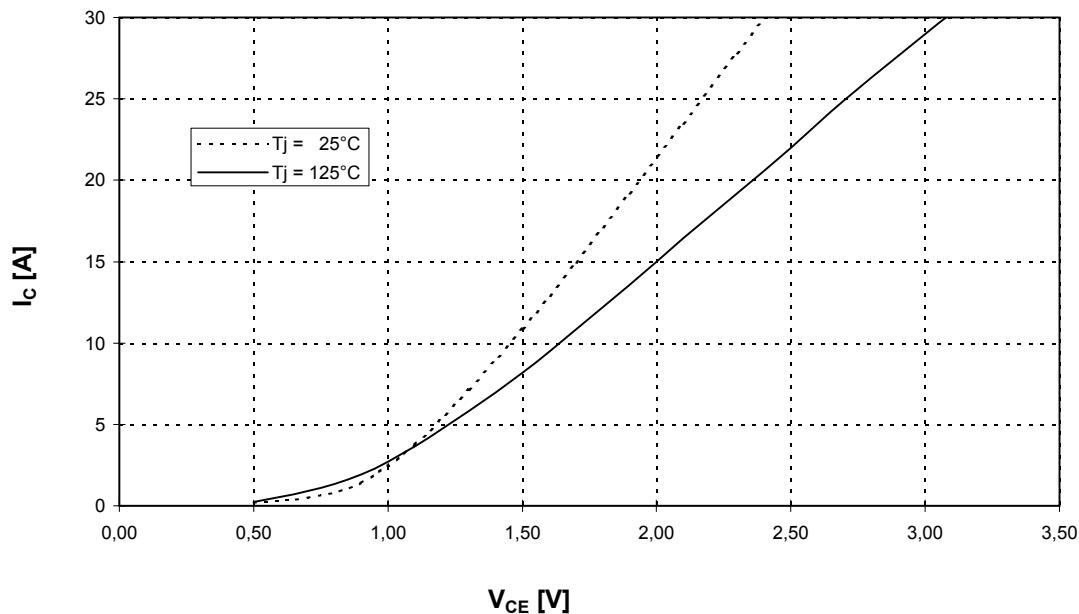
**Vorläufig**  
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**Ausgangskennlinienfeld Brems-Chopper-IGBT (typisch)**  $I_C = f(V_{CE})$

**Output characteristic brake-chopper-IGBT (typical)**

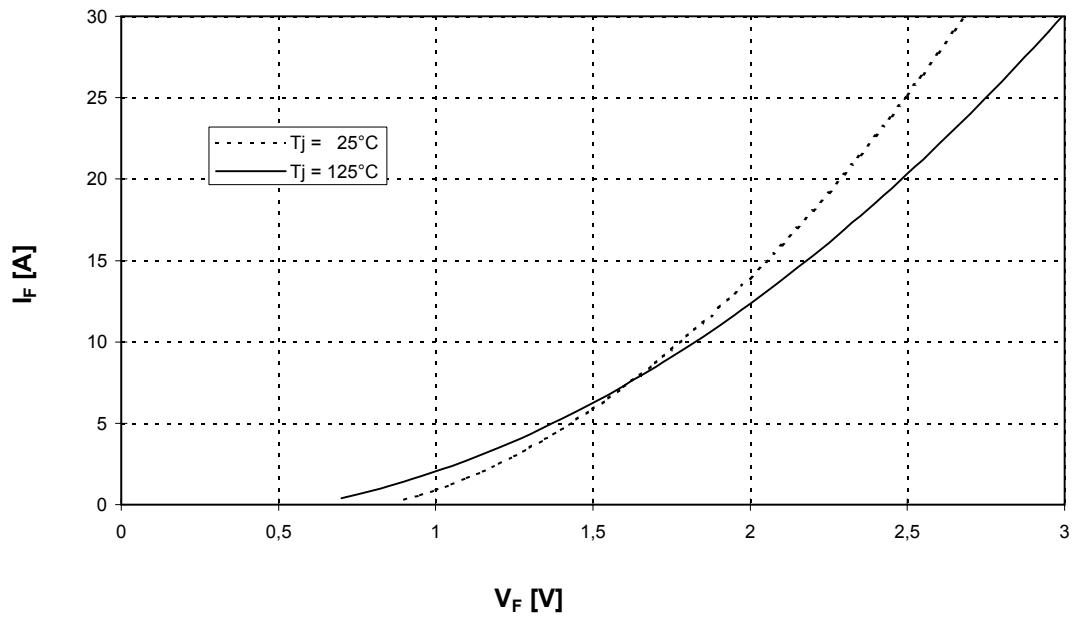
$$I_C = f(V_{CE})$$

$$V_{GE} = 15 \text{ V}$$



**Durchlaßkennlinie der Brems-Chopper-Diode (typisch)  $I_F = f(V_F)$**

**Forward characteristic of brake-chopper-FWD (typical)**



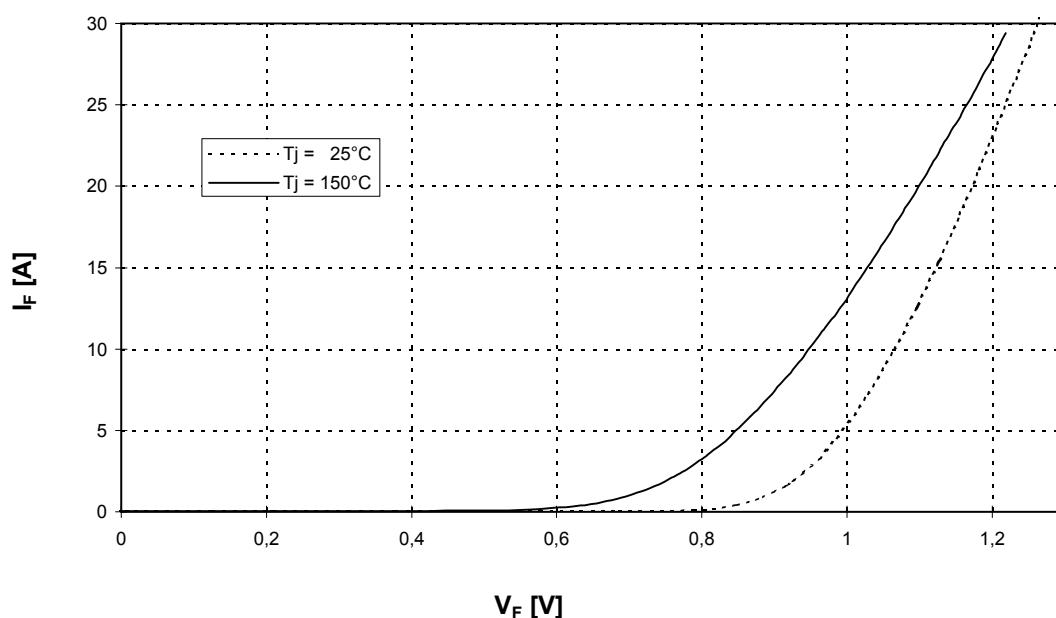


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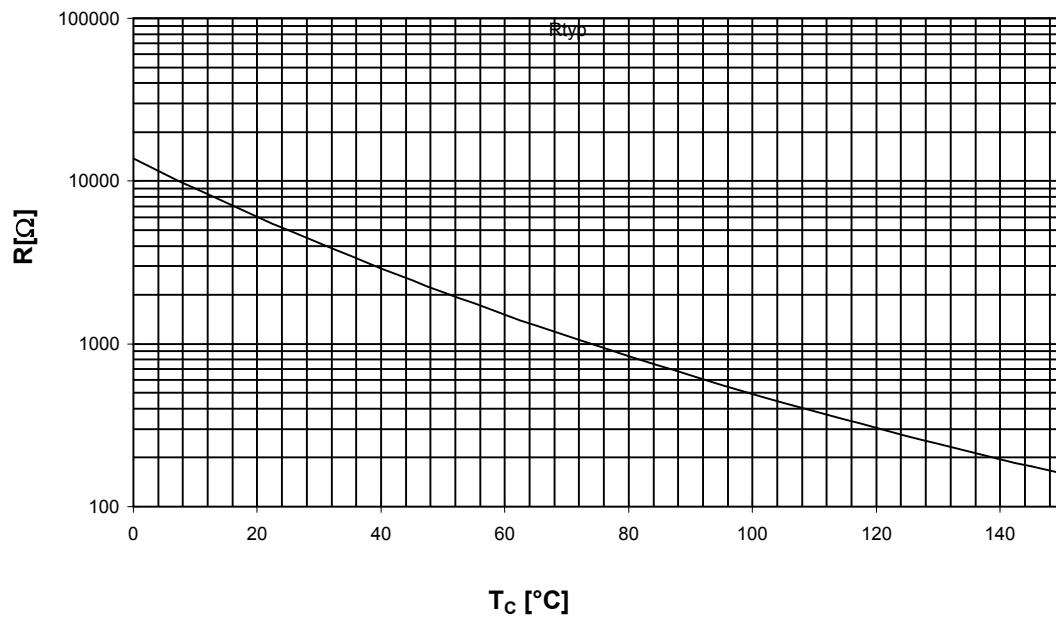
Durchlaßkennlinie der Gleichrichterdiode (typisch)

$$I_F = f(V_F)$$

Forward characteristic of Rectifier Diode (typical)



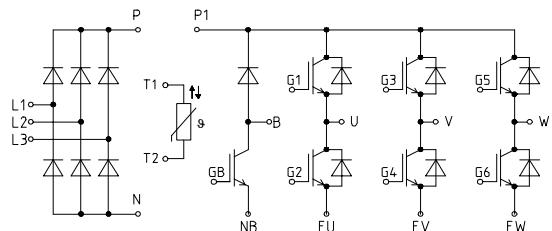
NTC- Temperaturkennlinie (typisch)       $R = f(T)$   
NTC- temperature characteristic (typical)





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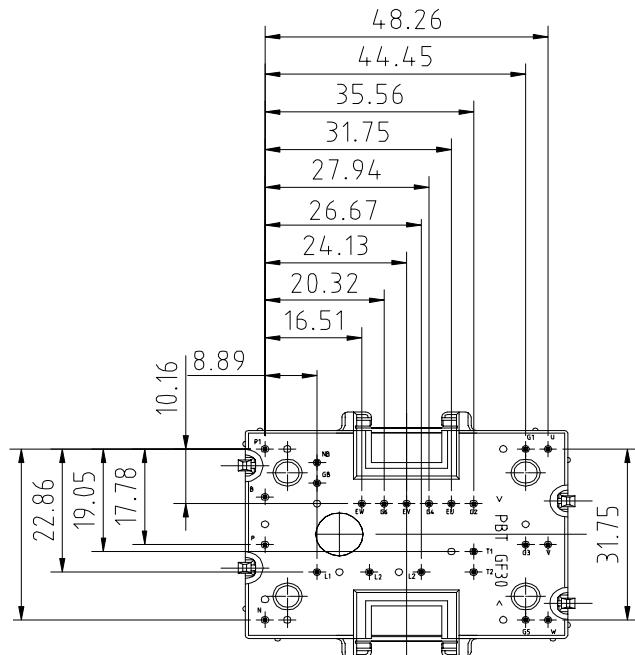
### Schaltplan/ Circuit diagram



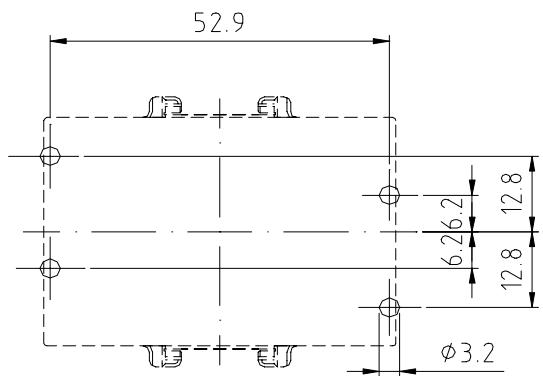
### Gehäuseabmessungen/ Package outlines

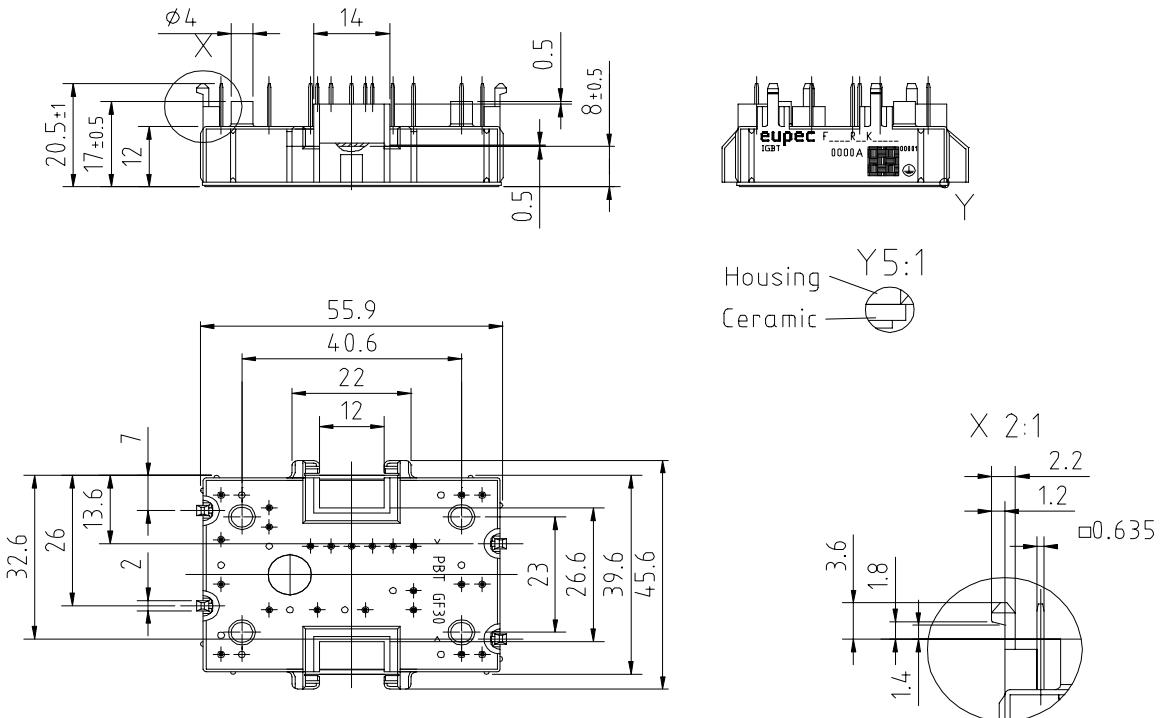
Modul only designed for mounting on PCB's with  $1.6 \pm 0.2$  mm thickness

Pinpositions with tolerance  $\phi 0.4$



Bohrplan /  
drilling layout



**Gehäuseabmessungen Forts. / Package outlines contd.**

Mit dieser technischen Information werden Halbleiterbauelemente spezifiziert, jedoch keine Eigenschaften zugesichert. Diese gilt in Verbindung mit den zugehörigen Technischen Erläuterungen.

This technical information specifies semiconductor devices but promises no characteristics. It is valid in combination with the belonging technical notes.